

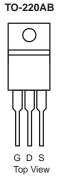
AP630P-VB Datasheet N-Channel 200 V (D-S) MOSFET

PRODUCT SUMMARY						
	V _{DS} (V)	$R_{DS(on)}(\Omega)$	I _D (A)			
	200	0.270 at V _{GS} = 10 V	10			

FEATURES

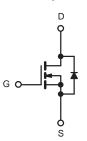
- DT-Trench Power MOSFET
- 175 °C Junction Temperature
- PWM Optimized
- 100 % R_g Tested
 Compliant to RoHS Directive 2002/95/EC





APPLICATIONS

Primary Side Switch



N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS (T _A = 25 °C, unless otherwise noted)							
Parameter	Symbol	Limit	Unit				
Drain-Source Voltage		V _{DS}	200				
Gate-Source Voltage	V _{GS}	± 20	V				
Continuous Drain Current (T _J = 175 °C) ^b	T _C = 25 °C	. I _D	10				
	T _C = 125 °C		6				
Pulsed Drain Current	sed Drain Current		38	А			
Continuous Source Current (Diode Conduction)	I _S	12					
Avalanche Current		I _{AS}	10				
Single Pulse Avalanche Energy	L = 0.1 mH	E _{AS}	18	mJ			
Maximum Power Dissipation	T _C = 25 °C	- P _D	121 ^b	W			
	T _A = 25 °C		2 ^a] vv			
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 175	°C			

THERMAL RESISTANCE RATINGS						
Parameter	Symbol	Typical	Maximum	Unit		
lunction-to-Ambient ^a	t ≤ 10 s	R _{thJA}	15	18	°C/W	
	Steady State	\ \thJA	40	50		
Junction-to-Case (Drain)		R _{thJC}	0.85	1.1		

- a. Surface mounted on 1" x 1" FR4 board.
- b. See SOA curve for voltage derating.



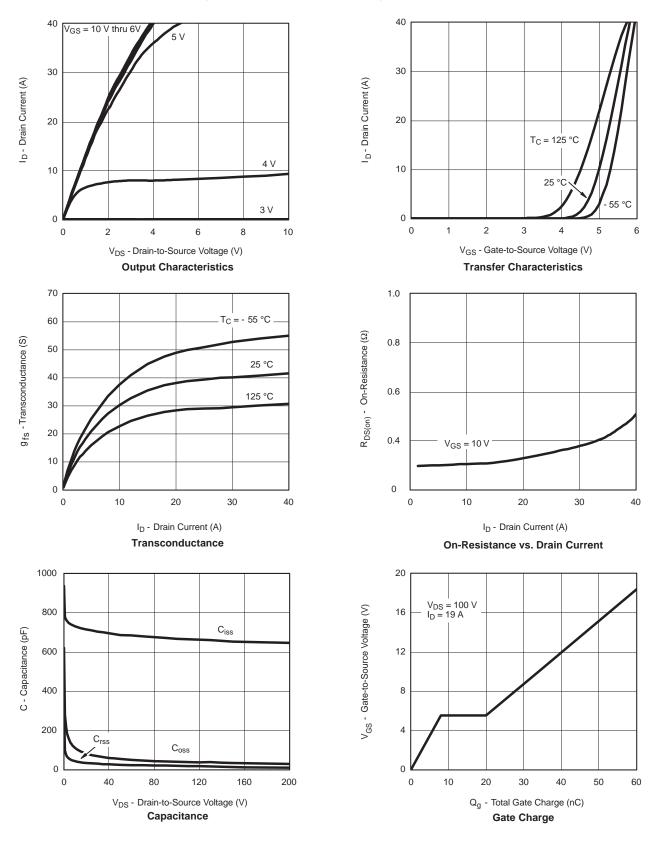
Parameter	Symbol	Test Conditions	Min.	Typ. ^a	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	200			V	
Gate Threshold Voltage			2		4	V	
Gate-Body Leakage					± 100	nA	
ero Gate Voltage Drain Current		V _{DS} = 200 V, V _{GS} = 0 V			1		
	I _{DSS}	V _{DS} = 200 V, V _{GS} = 0 V, T _J = 125 °C			50	μA	
		V _{DS} = 200 V, V _{GS} = 0 V, T _J = 175 °C			250		
On-State Drain Current ^b	I _{D(on)}	V _{DS} = 5 V, V _{GS} = 10 V	40			Α	
		V _{GS} = 10 V, I _D = 5 A		0.270			
Duting on the Control of the Control	D .	V _{GS} = 10 V, I _D = 5 A, T _J = 125 °C	0.320		0		
Drain-Source On-State Resistance ^b	R _{DS(on)}	V _{GS} = 10 V, I _D = 5 A, T _J = 175 °C		0.410		Ω	
		$V_{GS} = 4.5 \text{ V}, I_{D} = 5 \text{ A}$		0.310			
Forward Transconductance ^b	9 _{fs}	V _{DS} = 15 V, I _D = 19 A		35		S	
Dynamic ^a							
Input Capacitance	C _{iss}			800			
Output Capacitance	C _{oss}	V _{GS} = 0 V, V _{DS} = 25 V, F = 1 MHz		110		pF	
Reverse Transfer Capacitance	C _{rss}			80			
Total Gate Charge ^c	Q_g			30			
Gate-Source Charge ^c	Q _{gs}	$V_{DS} = 100 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 19 \text{ A}$		8		nC	
Gate-Drain Charge ^c	Q_{gd}			12			
Gate Resistance	R_g		0.5		2.9	Ω	
Turn-On Delay Time ^c	t _{d(on)}			15	25		
Rise Time ^c	t _r	$V_{DD} = 100 \text{ V}, R_{L} = 5.2 \Omega$		50	75	no	
Turn-Off Delay Time ^c	t _{d(off)}	$I_D \cong 19 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 2.5 \Omega$		30	45	ns	
Fall Time ^c	t _f			60	90		
Source-Drain Diode Ratings and Char	acteristics (7	_C = 25 °C)					
Pulsed Current	I _{SM}				40	Α	
Diode Forward Voltage ^b	V_{SD}	I _F = 19 A, V _{GS} = 0 V		0.9	1.5	V	
Source-Drain Reverse Recovery Time	t _{rr}	I _F = 19 A, dl/dt = 100 A/μs		180	250	ns	

- a. Guaranteed by design, not subject to production testing. b. Pulse test; pulse width $\leq 300~\mu s$, duty cycle $\leq 2~\%$. c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

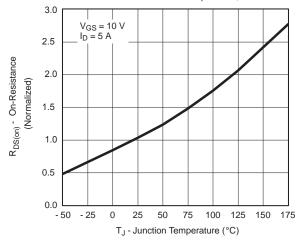


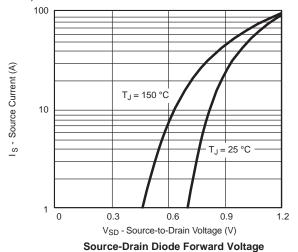
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)





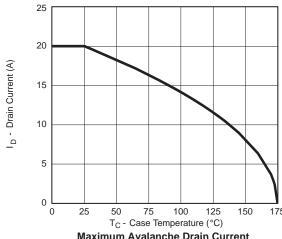
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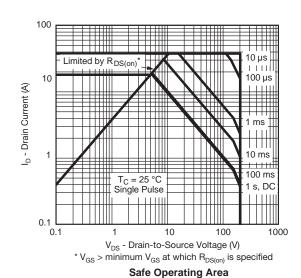




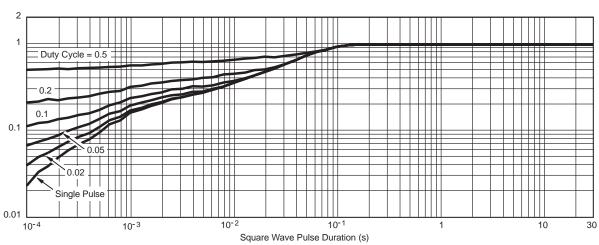
On-Resistance vs. Junction Temperature

THERMAL RATINGS









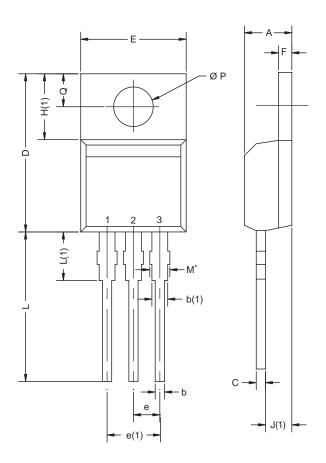
Normalized Thermal Transient Impedance, Junction-to-Case

服务热线:400-655-8788

Normalized Effective Transient Thermal Impedance



TO-220AB



	MILLIMETERS		INC	HES		
DIM.	MIN.	MAX.	MIN.	MAX.		
Α	4.25	4.65	0.167	0.183		
b	0.69	1.01	0.027	0.040		
b(1)	1.20	1.73	0.047	0.068		
С	0.36	0.61	0.014	0.024		
D	14.85	15.49	0.585	0.610		
E	10.04	10.51	0.395	0.414		
е	2.41	2.67	0.095	0.105		
e(1)	4.88	5.28	0.192	0.208		
F	1.14	1.40	0.045	0.055		
H(1)	6.09	6.48	0.240	0.255		
J(1)	2.41	2.92	0.095	0.115		
L	13.35	14.02	0.526	0.552		
L(1)	3.32	3.82	0.131	0.150		
ØΡ	3.54	3.94	0.139	0.155		
Q	2.60	3.00	0.102	0.118		
ECN: X12-0208-Rev. N, 08-Oct-12 DWG: 5471						

Notes

* M = 1.32 mm to 1.62 mm (dimension including protrusion)
Heatsink hole for HVM



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